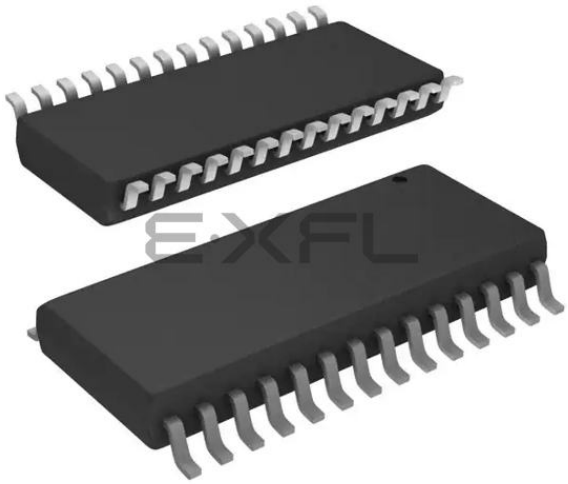


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

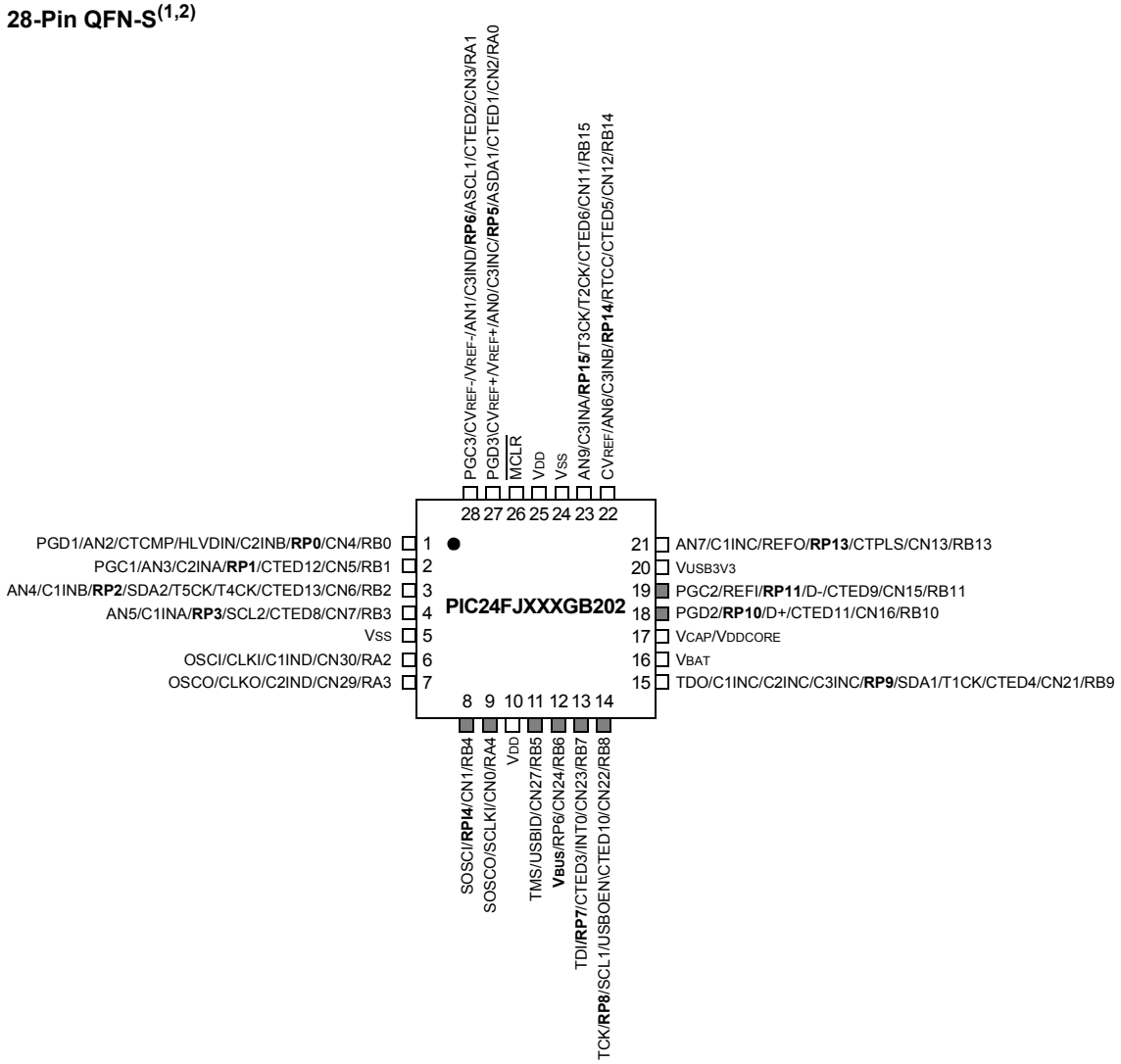
"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	AES, Brown-out Detect/Reset, DMA, I²S, HLVD, POR, PWM, WDT
Number of I/O	20
Program Memory Size	128KB (43K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 9x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj128gb202-i-so

Pin Diagrams (Continued)

28-Pin QFN-S(1,2)



Legend: **RPn** represents remappable peripheral pins.

Note 1: Gray shading indicates 5.5V tolerant input pins.

2: The back pad on QFN devices should be connected to VSS.

TABLE 1-3: PIC24FJ128GB204 FAMILY PINOUT DESCRIPTION (CONTINUED)

Pin Function	Pin Number/Grid Locator			I/O	Input Buffer	Description
	28-Pin SPDIP/SOIC/ SSOP	28-Pin QFN-S	44-Pin TQFP/QFN			
PMA0/PMALL	—	—	3	O	—	Parallel Master Port Address.
PMA1/PMALH	—	—	2	O	—	
PMA14/PMCS/ PMCS1	—	—	15	O	—	
PMA2/PMALU	—	—	12	O	—	
PMA3	—	—	38	O	—	
PMA4	—	—	37	O	—	
PMA5	—	—	4	O	—	
PMA6	—	—	5	O	—	
PMA7	—	—	13	O	—	
PMA8	—	—	32	O	—	
PMA9	—	—	35	O	—	
PMACK1	—	—	27	I	ST/TTL	Parallel Master Port Acknowledge Input 1.
PMBE0	—	—	36	O	—	Parallel Master Port Byte Enable 0 Strobe.
PMBE1	—	—	25	O	—	Parallel Master Port Byte Enable 1 Strobe.
PMCS1	—	—	30	I/O	ST/TTL	Parallel Master Port Chip Select 1 Strobe.
PMD0	—	—	21	I/O	ST/TTL	Parallel Master Port Data (Demultiplexed Master mode) or Address/Data (Multiplexed Master modes).
PMD1	—	—	22	I/O	ST/TTL	
PMD2	—	—	23	I/O	ST/TTL	
PMD3	—	—	1	I/O	ST/TTL	
PMD4	—	—	44	I/O	ST/TTL	
PMD5	—	—	43	I/O	ST/TTL	
PMD6	—	—	20	I/O	ST/TTL	
PMD7	—	—	19	I/O	ST/TTL	
PMRD	—	—	11	O	—	Parallel Master Port Read Strobe.
PMWR	—	—	24	O	—	Parallel Master Port Write Strobe.
RA0	2	27	19	I/O	ST	PORTA Digital I/Os.
RA1	3	28	20	I/O	ST	
RA2	9	6	30	I/O	ST	
RA3	10	7	31	I/O	ST	
RA4	12	9	34	I	ST	
RA7	—	—	13	I/O	ST	
RA8	—	—	32	I/O	ST	
RA9	—	—	35	I/O	ST	
RA10	—	—	12	I/O	ST	

Legend: ST = Schmitt Trigger input; TTL = TTL compatible input; I = Input
ANA = Analog input; O = Output; P = Power
I^2C = ST with I^2C™ or SMBus levels

2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT MICROCONTROLLERS

2.1 Basic Connection Requirements

Getting started with the PIC24FJ128GB204 family of 16-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and VSS pins
  (see **Section 2.2 "Power Supply Pins"**)
- All AVDD and AVSS pins, regardless of whether or not the analog device features are used
  (see **Section 2.2 "Power Supply Pins"**)
- MCLR pin
  (see **Section 2.3 "Master Clear (MCLR) Pin"**)
- ENVREG/DISVREG and VCAP/VDDCORE pins
  (see **Section 2.4 "Voltage Regulator Pins (ENVREG/DISVREG and VCAP/VDDCORE)"**)

These pins must also be connected if they are being used in the end application:

- PGECx/PGEDx pins used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes
  (see **Section 2.5 "ICSP Pins"**)
- OSCI and OSCO pins when an external oscillator source is used
  (see **Section 2.6 "External Oscillator Pins"**)

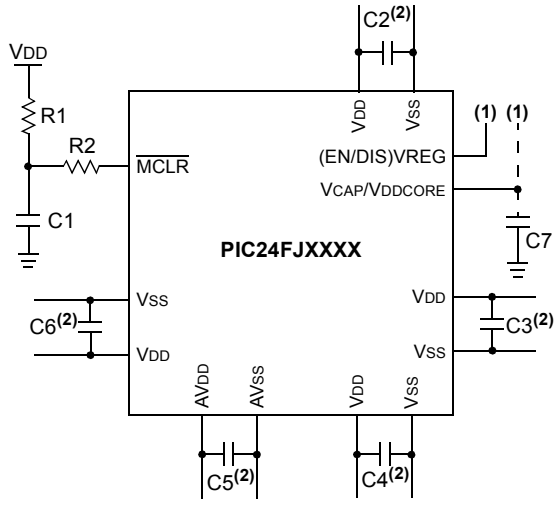
Additionally, the following pins may be required:

- VREF+/VREF- pins used when external voltage reference for analog modules is implemented

Note:	The AVDD and AVSS pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

FIGURE 2-1: RECOMMENDED MINIMUM CONNECTIONS



Key (all values are recommendations):

C1 through C6: 0.1 µF, 20V ceramic

C7: 10 µF, 6.3V or greater, tantalum or ceramic

R1: 10 kΩ

R2: 100Ω to 470Ω

Note 1: See **Section 2.4 "Voltage Regulator Pins (ENVREG/DISVREG and VCAP/VDDCORE)"** for the explanation of the ENVREG/DISVREG pin connections.

2: The example shown is for a PIC24F device with five VDD/VSS and AVDD/AVSS pairs. Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

2.4.1 CONSIDERATIONS FOR CERAMIC CAPACITORS

In recent years, large value, low-voltage, surface-mount ceramic capacitors have become very cost effective in sizes up to a few tens of microfarad. The low-ESR, small physical size and other properties make ceramic capacitors very attractive in many types of applications.

Ceramic capacitors are suitable for use with the internal voltage regulator of this microcontroller. However, some care is needed in selecting the capacitor to ensure that it maintains sufficient capacitance over the intended operating range of the application.

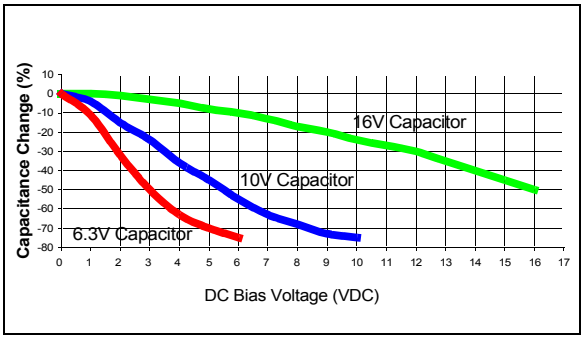
Typical low-cost, 10 μF ceramic capacitors are available in X5R, X7R and Y5V dielectric ratings (other types are also available, but are less common). The initial tolerance specifications for these types of capacitors are often specified as ±10% to ±20% (X5R and X7R), or -20%/+80% (Y5V). However, the effective capacitance that these capacitors provide in an application circuit will also vary based on additional factors, such as the applied DC bias voltage and the temperature. The total in-circuit tolerance is, therefore, much wider than the initial tolerance specification.

The X5R and X7R capacitors typically exhibit satisfactory temperature stability (ex: ±15% over a wide temperature range, but consult the manufacturer's data sheets for exact specifications). However, Y5V capacitors typically have extreme temperature tolerance specifications of +22%/-82%. Due to the extreme temperature tolerance, a 10 μF nominal rated Y5V type capacitor may not deliver enough total capacitance to meet minimum internal voltage regulator stability and transient response requirements. Therefore, Y5V capacitors are not recommended for use with the internal regulator if the application must operate over a wide temperature range.

In addition to temperature tolerance, the effective capacitance of large value ceramic capacitors can vary substantially, based on the amount of DC voltage applied to the capacitor. This effect can be very significant, but is often overlooked or is not always documented.

Typical DC bias voltage vs. capacitance graph for X7R type capacitors is shown in Figure 2-4.

FIGURE 2-4: DC BIAS VOLTAGE vs. CAPACITANCE CHARACTERISTICS



When selecting a ceramic capacitor to be used with the internal voltage regulator, it is suggested to select a high-voltage rating, so that the operating voltage is a small percentage of the maximum rated capacitor voltage. For example, choose a ceramic capacitor rated at 16V for the 2.5V or 1.8V core voltage. Suggested capacitors are shown in Table 2-1.

2.5 ICSP Pins

The PGECx and PGEDx pins are used for In-Circuit Serial Programming (ICSP) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100Ω.

Pull-up resistors, series diodes and capacitors on the PGECx and PGEDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits and pin input voltage high (V_{IH}) and input low (V_{IL}) requirements.

For device emulation, ensure that the "Communication Channel Select" (i.e., PGECx/PGEDx pins), programmed into the device, matches the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 31.0 "Development Support"**.

REGISTER 8-42: IPC22: INTERRUPT PRIORITY CONTROL REGISTER 22

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	SPI3TXIP2	SPI3TXIP1	SPI3TXIP0	—	SPI3IP2	SPI3IP1	SPI3IP0
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	U4TXIP2	U4TXIP1	U4TXIP0	—	U4RXIP2	U4RXIP1	U4RXIP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **SPI3TXIP<2:0>:** SPI3 Transmit Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **SPI3IP<2:0>:** SPI3 General Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **U4TXIP<2:0>:** UART4 Transmitter Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **U4RXIP<2:0>:** UART4 Receiver Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

REGISTER 9-5: REFOCONH: REFERENCE OSCILLATOR CONTROL HIGH REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	RODIV<14:8>						
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RODIV<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-0 **RODIV<14:0>:** Reference Oscillator Divisor Select bits
Specifies the 1/2 period of the reference clock in the source clocks.
For example: Period of ref_clk_output ≤ [Reference Source * 2] * RODIV<14:0>:
111111111111111 = REFO clock is the base clock frequency divided by 65,534 (32,767 * 2)
111111111111110 = REFO clock is the base clock frequency divided by 65,532 (32,766 * 2)
•
•
•
000000000000011 = REFO clock is the base clock frequency divided by 6 (3 * 2)
000000000000010 = REFO clock is the base clock frequency divided by 4 (2 * 2)
000000000000001 = REFO clock is the base clock frequency divided by 2 (1 * 2)
000000000000000 = REFO clock is the same frequency as the base clock (no divider)(1)

Note 1: The ROTRIMx values are ignored.

NOTES:

REGISTER 15-2: OCxCON2: OUTPUT COMPARE x CONTROL REGISTER 2

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
FLTMD	FLTOUT	FLTTRIEN	OCINV	—	DCB1(3)	DCB0(3)	OC32
bit 15							bit 8

R/W-0	R/W-0, HS	R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0
OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0
bit 7							bit 0

Legend:	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **FLTMD:** Fault Mode Select bit
1 = Fault mode is maintained until the Fault source is removed and the corresponding OCFLT0 bit is cleared in software
0 = Fault mode is maintained until the Fault source is removed and a new PWM period starts

bit 14 **FLTOUT:** Fault Out bit
1 = PWM output is driven high on a Fault
0 = PWM output is driven low on a Fault

bit 13 **FLTTRIEN:** Fault Output State Select bit
1 = Pin is forced to an output on a Fault condition
0 = Pin I/O condition is unaffected by a Fault

bit 12 **OCINV:** Output Compare x Invert bit
1 = OCx output is inverted
0 = OCx output is not inverted

bit 11 **Unimplemented:** Read as '0'

bit 10-9 **DCB<1:0>:** PWM Duty Cycle Least Significant bits(3)
11 = Delays OCx falling edge by ¾ of the instruction cycle
10 = Delays OCx falling edge by ½ of the instruction cycle
01 = Delays OCx falling edge by ¼ of the instruction cycle
00 = OCx falling edge occurs at the start of the instruction cycle

bit 8 **OC32:** Cascade Two OC Modules Enable bit (32-bit operation)
1 = Cascade module operation is enabled
0 = Cascade module operation is disabled

bit 7 **OCTRIG:** Output Compare x Trigger/Sync Select bit
1 = Triggers OCx from the source designated by the SYNCSELx bits
0 = Synchronizes OCx with the source designated by the SYNCSELx bits

bit 6 **TRIGSTAT:** Timer Trigger Status bit
1 = Timer source has been triggered and is running
0 = Timer source has not been triggered and is being held clear

bit 5 **OCTRIS:** Output Compare x Output Pin Direction Select bit
1 = OCx pin is tri-stated
0 = Output Compare Peripheral x is connected to an OCx pin

Note 1: Never use an OCx module as its own trigger source, either by selecting this mode or another equivalent SYNCSELx setting.
2: Use these inputs as trigger sources only and never as sync sources.
3: The DCB<1:0> bits are double-buffered in PWM modes only (OCM<2:0> (OCxCON1<2:0>) = 111, 110).

REGISTER 16-2: SPIxCON1H: SPIx CONTROL REGISTER 1 HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
AUDEN(1)	SPISGNEXT	IGNROV	IGNTUR	AUDMONO(2)	URDTEN(3)	AUDMOD1(4)	AUDMOD0(4)
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FRMCNT2	FRMCNT1	FRMCNT0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **AUDEN:** Audio Codec Support Enable bit(1)
- 1 = Audio protocol is enabled; MSTEN controls the direction of both SCKx and Frame (a.k.a. LRC), and this module functions as if FRMEN = 1, FRMSYNC = MSTEN, FRMCNT<2:0> = 001 and SMP = 0, regardless of their actual values
- 0 = Audio protocol is disabled

bit 14 **SPISGNEXT:** SPIx Sign-Extend RX FIFO Read Data Enable bit
- 1 = Data from RX FIFO is sign-extended
- 0 = Data from RX FIFO is not sign-extended

bit 13 **IGNROV:** Ignore Receive Overflow bit
- 1 = A Receive Overflow (ROV) is NOT a critical error; during ROV, data in the FIFO is not overwritten by the receive data
- 0 = A ROV is a critical error that stops SPI operation

bit 12 **IGNTUR:** Ignore Transmit Underrun bit
- 1 = A Transmit Underrun (TUR) is NOT a critical error and data indicated by URDTEN is transmitted until the SPIxTXB is not empty
- 0 = A TUR is a critical error that stops SPI operation

bit 11 **AUDMONO:** Audio Data Format Transmit bit(2)
- 1 = Audio data is mono (i.e., each data word is transmitted on both left and right channels)
- 0 = Audio data is stereo

bit 10 **URDTEN:** Transmit Underrun Data Enable bit(3)
- 1 = Transmits data out of SPIxURDTL/H registers during Transmit Underrun (TUR) conditions
- 0 = Transmits the last received data during Transmit Underrun conditions

bit 9-8 **AUDMOD<1:0>:** Audio Protocol Mode Selection bits(4)
- 11 = PCM/DSP mode
- 10 = Right Justified mode: This module functions as if SPIFE = 1, regardless of its actual value
- 01 = Left Justified mode: This module functions as if SPIFE = 1, regardless of its actual value
- 00 = I^2S mode: This module functions as if SPIFE = 0, regardless of its actual value

bit 7 **FRMEN:** Framed SPIx Support bit
- 1 = Framed SPIx support is enabled ($\overline{SSx}$ pin is used as the FSYNC input/output)
- 0 = Framed SPIx support is disabled

Note 1: AUDEN can only be written when the SPIEN bit = 0.

2: AUDMONO can only be written when the SPIEN bit = 0 and is only valid for AUDEN = 1.

3: URDTEN is only valid when IGNTUR = 1.

4: AUDMOD<1:0> can only be written when the SPIEN bit = 0 and are only valid when AUDEN = 1. When NOT in PCM/DSP mode, this module functions as if FRMSYPW = 1, regardless of its actual value.

REGISTER 16-7: SPIxIMSKH: SPIx INTERRUPT MASK REGISTER HIGH

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RXWIEN	—	RXMSK5(1)	RXMSK4(1,4)	RXMSK3(1,3)	RXMSK2(1,2)	RXMSK1(1)	RXMSK0(1)
bit 15							bit 8

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TXWIEN	—	TXMSK5(1)	TXMSK4(1,4)	TXMSK3(1,3)	TXMSK2(1,2)	TXMSK1(1)	TXMSK0(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **RXWIEN:** Receive Watermark Interrupt Enable bit
1 = Triggers receive buffer element watermark interrupt when RXMSK<5:0> ≤ RXELM<5:0>
0 = Disables receive buffer element watermark interrupt

bit 14 **Unimplemented:** Read as '0'

bit 13-8 **RXMSK<5:0>:** RX Buffer Mask bits(1,2,3,4)
RX mask bits; used in conjunction with the RXWIEN bit.

bit 7 **TXWIEN:** Transmit Watermark Interrupt Enable bit
1 = Triggers transmit buffer element watermark interrupt when TXMSK<5:0> = TXELM<5:0>
0 = Disables transmit buffer element watermark interrupt

bit 6 **Unimplemented:** Read as '0'

bit 5-0 **TXMSK<5:0>:** TX Buffer Mask bits(1,2,3,4)
TX mask bits; used in conjunction with the TXWIEN bit.

Note 1: Mask values higher than FIFODEPTH are not valid. The module will not trigger a match for any value in this case.
2: RXMSK2 and TXMSK2 bits are only present when FIFODEPTH = 8 or higher.
3: RXMSK3 and TXMSK3 bits are only present when FIFODEPTH = 16 or higher.
4: RXMSK4 and TXMSK4 bits are only present when FIFODEPTH = 32.

REGISTER 19-2: BDnSTAT: BUFFER DESCRIPTOR n STATUS REGISTER PROTOTYPE, CPU MODE (BD0STAT THROUGH BD63STAT)

R/W-x	R/W-x	r-0	r-0	R/W-x	R/W-x	R/W-x, HSC	R/W-x, HSC
UOWN	DTS(1)	—	—	DTSEN	BSTALL	BC9	BC8
bit 15							bit 8

R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC
BC7	BC6	BC5	BC4	BC3	BC2	BC1	BC0
bit 7							bit 0

Legend:	r = Reserved bit	HSC = Hardware Settable/Clearable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'r' = Reserved bit	x = Bit is unknown

bit 15 **UOWN:** USB Own bit
0 = The microcontroller core owns the BD and its corresponding buffer; the USB module ignores all other fields in the BD

bit 14 **DTS:** Data Toggle Packet bit(1)
1 = Data 1 packet
0 = Data 0 packet

bit 13-12 **Reserved:** Maintain as '0'

bit 11 **DTSEN:** Data Toggle Synchronization Enable bit
1 = Data toggle synchronization is enabled; data packets with incorrect Sync value will be ignored
0 = No data toggle synchronization is performed

bit 10 **BSTALL:** Buffer STALL Enable bit
1 = Buffer STALL is enabled; STALL handshake is issued if a token is received that would use the BD in the given location (UOWN bit remains set, BD value is unchanged); corresponding EPSTALL bit will get set on any STALL handshake
0 = Buffer STALL is disabled

bit 9-0 **BC<9:0>:** Byte Count bits
This represents the number of bytes to be transmitted or the maximum number of bytes to be received during a transfer. Upon completion, the byte count is updated by the USB module with the actual number of bytes transmitted or received.

Note 1: This bit is ignored unless DTSEN = 1.

REGISTER 19-16: U1IR: USB INTERRUPT STATUS REGISTER (DEVICE MODE ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/K-0, HS	U-0	R/K-0, HS	R/K-0, HS	R/K-0, HS	R/K-0, HS	R-0	R/K-0, HS
STALLIF	—	RESUMEIF	IDLEIF	TRNIF	SOFIF	UERRIF	URSTIF
bit 7							bit 0

Legend:	U = Unimplemented bit, read as '0'		
R = Readable bit	K = Write '1' to Clear bit	HS = Hardware Settable bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 **STALLIF:** STALL Handshake Interrupt bit
- 1 = A STALL handshake was sent by the peripheral during the handshake phase of the transaction in Device mode
- 0 = A STALL handshake has not been sent

bit 6 **Unimplemented:** Read as '0'

bit 5 **RESUMEIF:** Resume Interrupt bit
- 1 = A K-state is observed on the D+ or D- pin for 2.5 μs (differential '1' for low speed, differential '0' for full speed)
- 0 = No K-state is observed

bit 4 **IDLEIF:** Idle Detect Interrupt bit
- 1 = Idle condition is detected (constant Idle state of 3 ms or more)
- 0 = No Idle condition is detected

bit 3 **TRNIF:** Token Processing Complete Interrupt bit
- 1 = Processing of the current token is complete; read the U1STAT register for endpoint information
- 0 = Processing of the current token is not complete; clear the U1STAT register or load the next token from U1STAT (clearing this bit causes the U1STAT FIFO to advance)

bit 2 **SOFIF:** Start-of-Frame Token Interrupt bit
- 1 = A Start-of-Frame token is received by the peripheral or the Start-of-Frame threshold is reached by the host
- 0 = No Start-of-Frame token is received or threshold reached

bit 1 **UERRIF**: USB Error Condition Interrupt bit (read-only)
- 1 = An unmasked error condition has occurred; only error states enabled in the U1EIE register can set this bit
- 0 = No unmasked error condition has occurred

bit 0 **URSTIF:** USB Reset Interrupt bit
- 1 = Valid USB Reset has occurred for at least 2.5 μs; Reset state must be cleared before this bit can be reasserted
- 0 = No USB Reset has occurred. Individual bits can only be cleared by writing a '1' to the bit position as part of a word write operation on the entire register. Using Boolean instructions or bitwise operations to write to a single bit position will cause all set bits, at the moment of the write, to become cleared.

Note: Individual bits can only be cleared by writing a '1' to the bit position as part of a word write operation on the entire register. Using Boolean instructions or bitwise operations to write to a single bit position will cause all set bits, at the moment of the write, to become cleared.

23.5.8 PROGRAMMING CFGPAGE (PAGE 0) CONFIGURATION BITS

1. If not already set, set the CRYON bit. Set KEYPG<3:0> to '0000'.
2. Read the PGMFAIL status bit. If this bit is '1', an illegal configuration has been selected and the programming operation will not be performed.
3. Write the data to be programmed into the Configuration Page into CRYTXTC<31:0>. Any bits that are set ('1') will be permanently programmed, while any bits that are cleared ('0') will not be programmed and may be programmed at a later time.
4. Set the CRYWR bit. Poll the bit until it is cleared; alternatively, set the OTPIE bit (CRYOTP<6>) to enable the optional OTP done interrupt.
5. Once all programming has completed, set the CRYREAD bit to reload the values from the on-chip storage. A read operation must be performed to complete programming.

Note:	Do not clear the CRYON bit while the CRYREAD bit is set; this will result in an incomplete read operation and unavailable key data. To recover, set CRYON and CRYREAD, and allow the read operation to fully complete.

6. Poll the CRYREAD bit until it is cleared; alternatively, set the OTPIE bit (CRYOTP<6>) to enable the optional OTP done interrupt.
7. For production programming, the TSTPGM bit can be set to indicate a successful programming operation. When TSTPGM is set, the PGMTST bit (CRYOTP<7>) will also be set, allowing users to see the OTP array status with performing a read operation on the array.

Note:	If the device enters Sleep mode during OTP programming, the contents of the OTP array may become corrupted. This is not a recoverable error. Users must ensure that entry into power-saving modes is disabled before OTP programming is performed.

23.5.9 PROGRAMMING KEYS

1. If not already set, set the CRYON bit.
2. Configure KEYPG<3:0> to the page you want to program.
3. Read the PGMFAIL status bit. If this bit is '1', an illegal configuration has been selected and the programming operation will not be performed.
4. Write the data to be programmed into the Configuration Page into CRYTXTC<63:0>. Any bits that are set ('1') will be permanently programmed, while any bits that are cleared ('0') will not be programmed and may be programmed at a later time.
5. Set the CRYWR bit. Poll the bit until it is cleared; alternatively, set the OTPIE bit (CRYOTP<6>) to enable the optional OTP done interrupt.
6. Repeat Steps 2 through 5 for each OTP array page to be programmed.
7. Once all programming has completed, set the CRYREAD bit to reload the values from the on-chip storage. A read operation must be performed to complete programming.

Note:	Do not clear the CRYON bit while the CRYREAD bit is set; this will result in an incomplete read operation and unavailable key data. To recover, set CRYON and CRYREAD, and allow the read operation to fully complete.

8. Poll the CRYREAD bit until it is cleared; alternatively, set the OTPIE bit (CRYOTP<6>) to enable the optional OTP done interrupt.
9. For production programming, the TSTPGM bit can be set to indicate a successful programming operation. When TSTPGM is set, the PGMTST bit (CRYOTP<7>) will also be set, allowing users to see the OTP array status with performing a read operation on the array.

Note:	If the device enters Sleep Mode during OTP programming, the contents of the OTP array may become corrupted. This is not a recoverable error. Users must ensure that entry into power-saving modes is disabled before OTP programming is performed.

23.5.10 VERIFYING PROGRAMMED KEYS

To maintain key security, the secure OTP array has no provision to read back its data to any user-accessible memory space in any operating mode. Therefore, there is no way to directly verify programmed data. The only method for verifying that they have been programmed correctly is to perform an encryption operation with a known plaintext/ciphertext pair for each programmed key.

REGISTER 25-2: AD1CON2: ADC1 CONTROL REGISTER 2 (CONTINUED)

bit 6-2 **SMPI<4:0>:** Interrupt Sample/DMA Increment Rate Select bits

When DMAEN = 1:

11111 = Increments the DMA address after completion of the 32nd sample/conversion operation
11110 = Increments the DMA address after completion of the 31st sample/conversion operation
•
•
•
00001 = Increments the DMA address after completion of the 2nd sample/conversion operation
00000 = Increments the DMA address after completion of each sample/conversion operation

When DMAEN = 0:

11111 = Interrupts at the completion of the conversion for each 32nd sample
11110 = Interrupts at the completion of the conversion for each 31st sample
•
•
•
00001 = Interrupts at the completion of the conversion for every other sample
00000 = Interrupts at the completion of the conversion for each sample

bit 1 **BUFM:** Buffer Fill Mode Select bit(1)

1 = Starts buffer filling at ADC1BUF0 on the first interrupt and ADC1BUF8 on the next interrupt
0 = Always starts filling buffer at ADC1BUF0

bit 0 **ALTS:** Alternate Input Sample Mode Select bit

1 = Uses channel input selects for Sample A on the first sample and Sample B on the next sample
0 = Always uses channel input selects for Sample A

Note 1: These bits are only applicable when the buffer is used in FIFO mode (BUFREGEN = 0). In addition, BUFS is only used when BUFM = 1.

REGISTER 25-5: AD1CON5: ADC1 CONTROL REGISTER 5

R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
ASEN	LPEN	CTMREQ	BGREQ	—	—	ASINT1	ASINT0
bit 15							bit 8

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	WM1	WM0	CM1	CM0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **ASEN:** Auto-Scan Enable bit
1 = Auto-scan is enabled
0 = Auto-scan is disabled

bit 14 **LPEN:** Low-Power Enable bit
1 = Low power is enabled after scan
0 = Full power is enabled after scan

bit 13 **CTMREQ:** CTMU Request bit
1 = CTMU is enabled when the A/D is enabled and active
0 = CTMU is not enabled by the A/D

bit 12 **BGREQ:** Band Gap Request bit
1 = Band gap is enabled when the A/D is enabled and active
0 = Band gap is not enabled by the A/D

bit 11-10 **Unimplemented:** Read as '0'

bit 9-8 **ASINT<1:0>:** Auto-Scan (Threshold Detect) Interrupt Mode bits
11 = Interrupt after Threshold Detect sequence completed and valid compare has occurred
10 = Interrupt after valid compare has occurred
01 = Interrupt after Threshold Detect sequence completed
00 = No interrupt

bit 7-4 **Unimplemented:** Read as '0'

bit 3-2 **WM<1:0>:** Write Mode bits
11 = Reserved
10 = Auto-compare only (conversion results are not saved, but interrupts are generated when a valid match occurs, as defined by the CMx and ASINTx bits)
01 = Convert and save (conversion results are saved to locations as determined by the register bits when a match occurs, as defined by the CMx bits)
00 = Legacy operation (conversion data is saved to a location determined by the buffer register bits)

bit 1-0 **CM<1:0>:** Compare Mode bits
11 = Outside Window mode (valid match occurs if the conversion result is outside of the window defined by the corresponding buffer pair)
10 = Inside Window mode (valid match occurs if the conversion result is inside the window defined by the corresponding buffer pair)
01 = Greater Than mode (valid match occurs if the result is greater than the value in the corresponding buffer register)
00 = Less Than mode (valid match occurs if the result is less than the value in the corresponding buffer register)

REGISTER 28-3: CTMUICON: CTMU CURRENT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-10 **ITRIM<5:0>:** Current Source Trim bits
011111 = Maximum positive change from nominal current
011110
•
•
•
000001 = Minimum positive change from nominal current
000000 = Nominal current output specified by IRNG<1:0>
111111 = Minimum negative change from nominal current
•
•
•
100010
100001 = Maximum negative change from nominal current

bit 9-8 **IRNG<1:0>:** Current Source Range Select bits
11 = 100 × Base Current
10 = 10 × Base Current
01 = Base current level (0.55 μA nominal)
00 = 1000 × Base Current

bit 7-0 **Unimplemented:** Read as '0'

33.2 AC Characteristics and Timing Parameters

The information contained in this section defines the PIC24FJ128GB204 family AC characteristics and timing parameters.

TABLE 33-18: TEMPERATURE AND VOLTAGE SPECIFICATIONS – AC

AC CHARACTERISTICS	**Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended Operating voltage VDD range as described in **Section 33.1 "DC Characteristics"**.

FIGURE 33-2: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

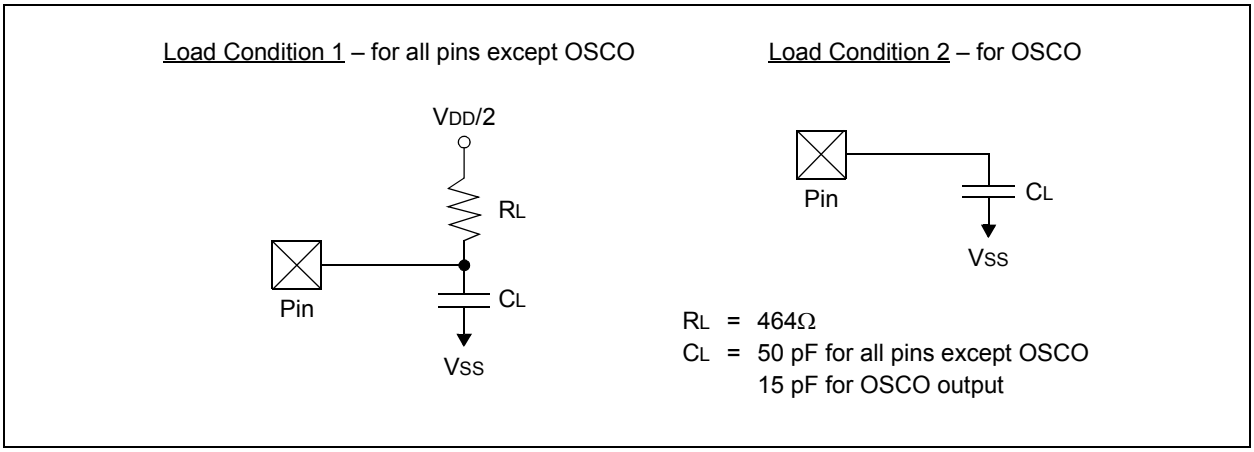
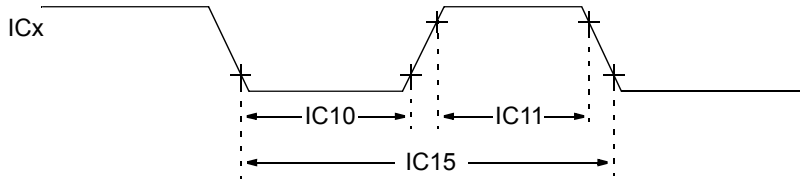


TABLE 33-19: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

Param No.	Symbol	Characteristic	Min	Typ(1)	Max	Units	Conditions
DO50	COSCO	OSCO/CLKO Pin	—	—	15	pF	In XT and HS modes when external clock is used to drive OSCI
DO56	CIO	All I/O Pins and OSCO	—	—	50	pF	EC mode
DO58	CB	SCLx, SDAx	—	—	400	pF	In I^2C™ mode

Note 1: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 33-6: INPUT CAPTURE x (ICx) TIMING CHARACTERISTICS



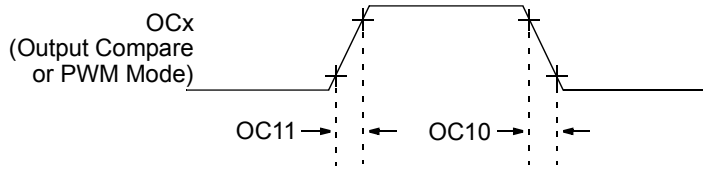
Note: Refer to Figure 33-2 for load conditions.

TABLE 33-29: INPUT CAPTURE x TIMING REQUIREMENTS

AC CHARACTERISTICS				Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Param No.	**Symbol**	**Characteristic(1)**		**Min**	**Max**	**Units**	**Conditions**
IC10	TccL	ICx Input Low Time	No Prescaler	0.5 TCY + 20	—	ns	
			With Prescaler	10	—	ns	
IC11	TccH	ICx Input High Time	No Prescaler	0.5 TCY + 20	—	ns	
			With Prescaler	10	—	ns	
IC15	TccP	ICx Input Period		(TCY + 40)/N	—	ns	N = Prescale Value (1, 4, 16)

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 33-7: OUTPUT COMPARE x MODULE (OCx) TIMING CHARACTERISTICS



Note: Refer to Figure 33-2 for load conditions.

TABLE 33-30: OUTPUT COMPARE x MODULE TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
OC10	TccF	OCx Output Fall Time	—	—	—	ns	See Parameter DO32
OC11	TccR	OCx Output Rise Time	—	—	—	ns	See Parameter DO31

Note 1: These parameters are characterized but not tested in manufacturing.

NOTES:

NOTES: